Appl. No. 10/575,581; Docket No. NL03 1276 US1

Amdt. dated April 28, 2008

Response to Office Action dated March 26, 2008

Amendments to the Claims

Claims 1-4 (Cancelled)

5. (Original) An electronic device provided with an electric element and an

encapsulation of electrically insulating material, and a carrier with a first side facing

the element and an opposed second side, said carrier comprising:

- a patterned connection layer

- contact pads for coupling to an external carrier or an

element, and

- an intermediate layer of electrically conductive material, which is patterned

so as to create interconnects between the interconnection layer and the contact pads,

interconnects are mutually isolated by isolation areas, the encapsulation extending

into the isolation areas,

- wherein a protective layer is present at the second side of the carrier so as to

protect an interface between the intermediate layer and the contact pads.

6. (Original) An electronic device as claimed in Claim 5, wherein the bond pads and

any other conducting elements at the first side of the carrier are mechanically

anchored in the encapsulation.

7. (Previously Presented) An electronic device as claimed in claim 5, wherein at least

a number of contact pads is laterally displaced with respect to the corresponding bond

pads.

8. (Original) An electronic device as claimed in Claim 5, wherein the protective layer

laterally extends so as to cover the intermediate layer.

9. (Original) An electronic device as claimed in Claim 5, wherein:

- the contact pads comprise a main layer and a masking layer, said masking

layer being present at the second side of the carrier and having a larger surface area

than the main layer, and

Page 2 of 4

Appl. No. 10/575,581; Docket No. NL03 1276 US1 Amdt. dated April 28, 2008

Response to Office Action dated March 26, 2008

- the protective layer is substantially present between the masking layer and the intermediate layer, such that on perpendicular projection of the protective layer on the masking layer there is a substantial overlap.

10. (Original) An electronic device as claimed in Claim 5, wherein the electric element is a semiconductor device, that is at least partially encapsulated in the encapsulation.